



Qualcomm Technologies, Inc.

## M2X75 Photographs

80-75323-9 Rev. AC

July 24, 2024

Qualcomm  
Confidential - May Contain Trade Secrets  
2024-07-28 23:51:14 GMT  
anne-kuo@sporton.com.tw

# Revision history

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Revision	Date	Description
AA	June 2024	Initial release
AB	July 2024	Updated
AC	July 2024	Updated

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## 1 Model information

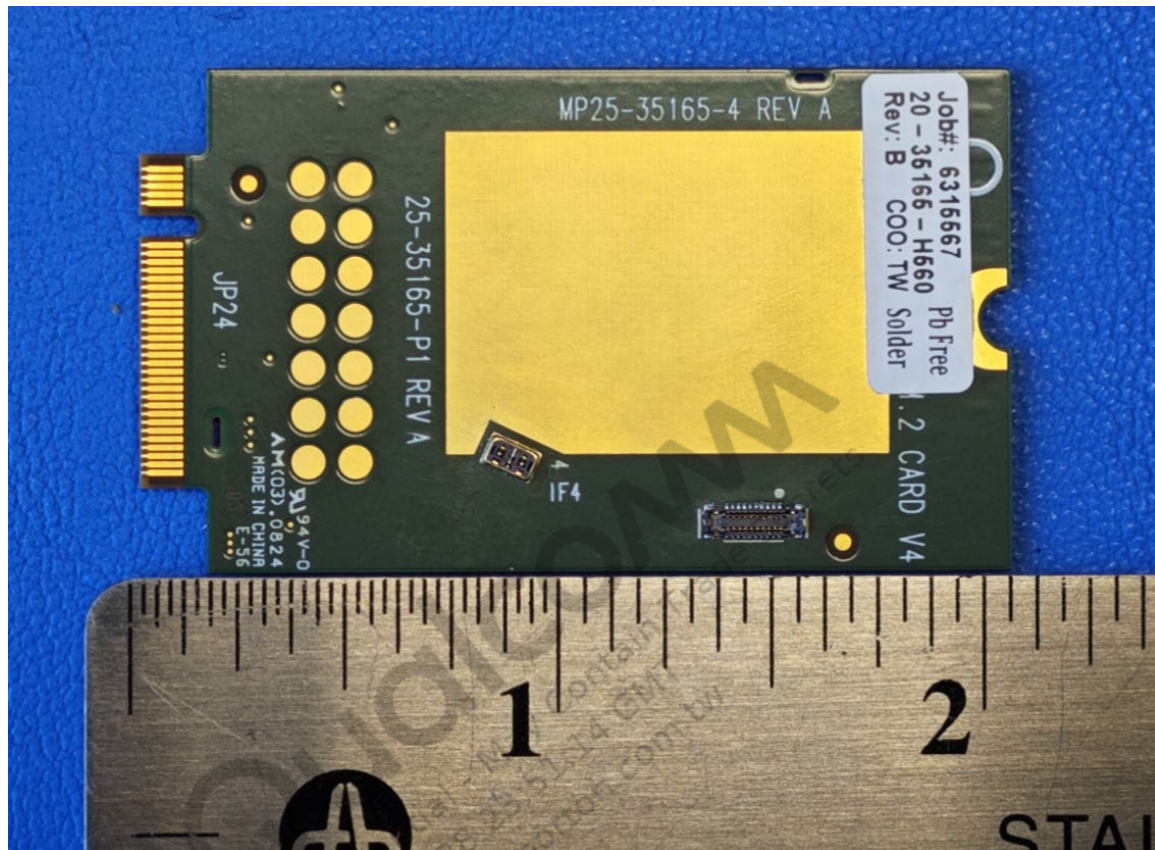
- Brand Name: Qualcomm
- Model name: M2X75
- FCC ID: J9C-M2X75
- ISED ID: 2723A-M2X75

## 2 External Photographs

### 2.1 Front

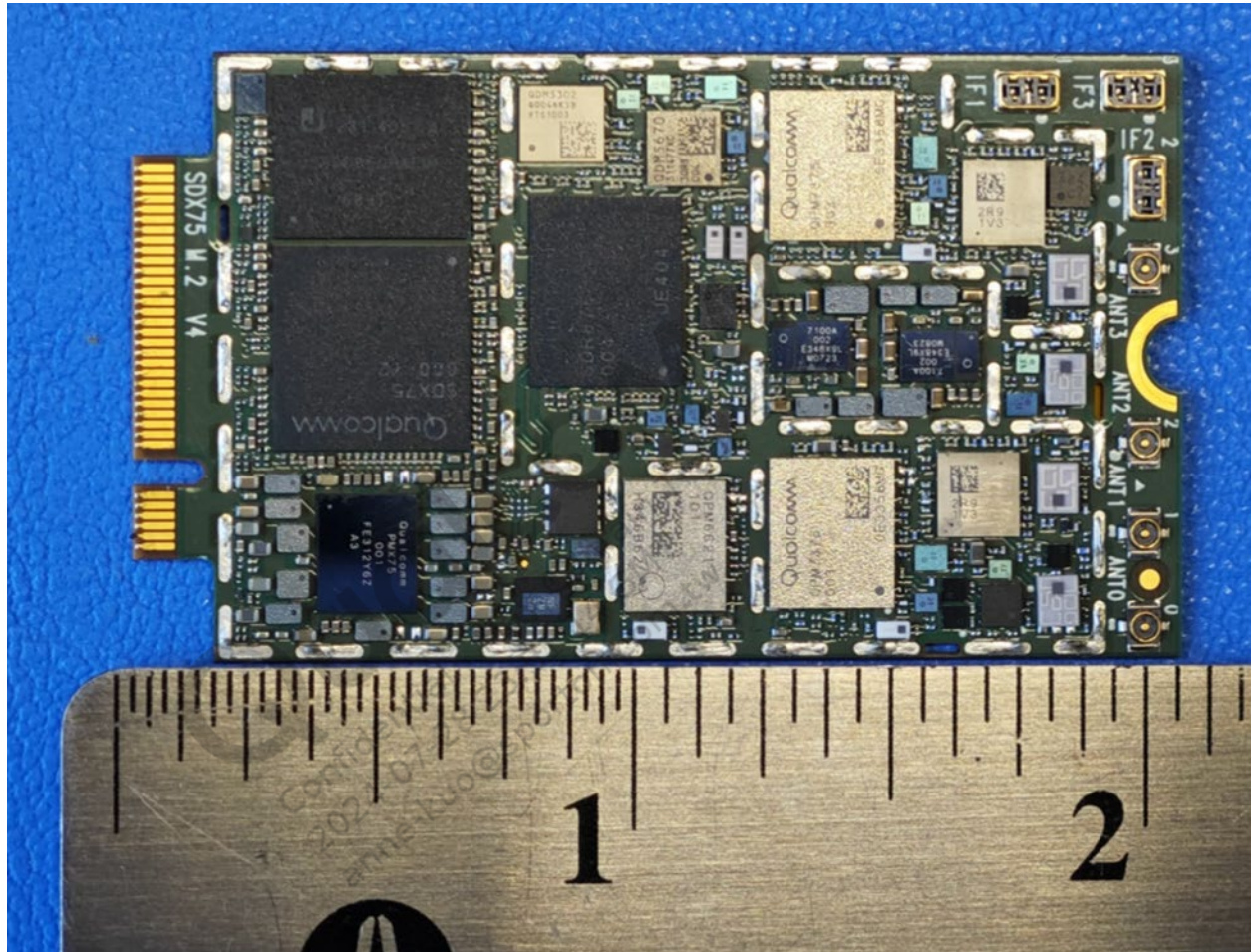


## 2.2 Back



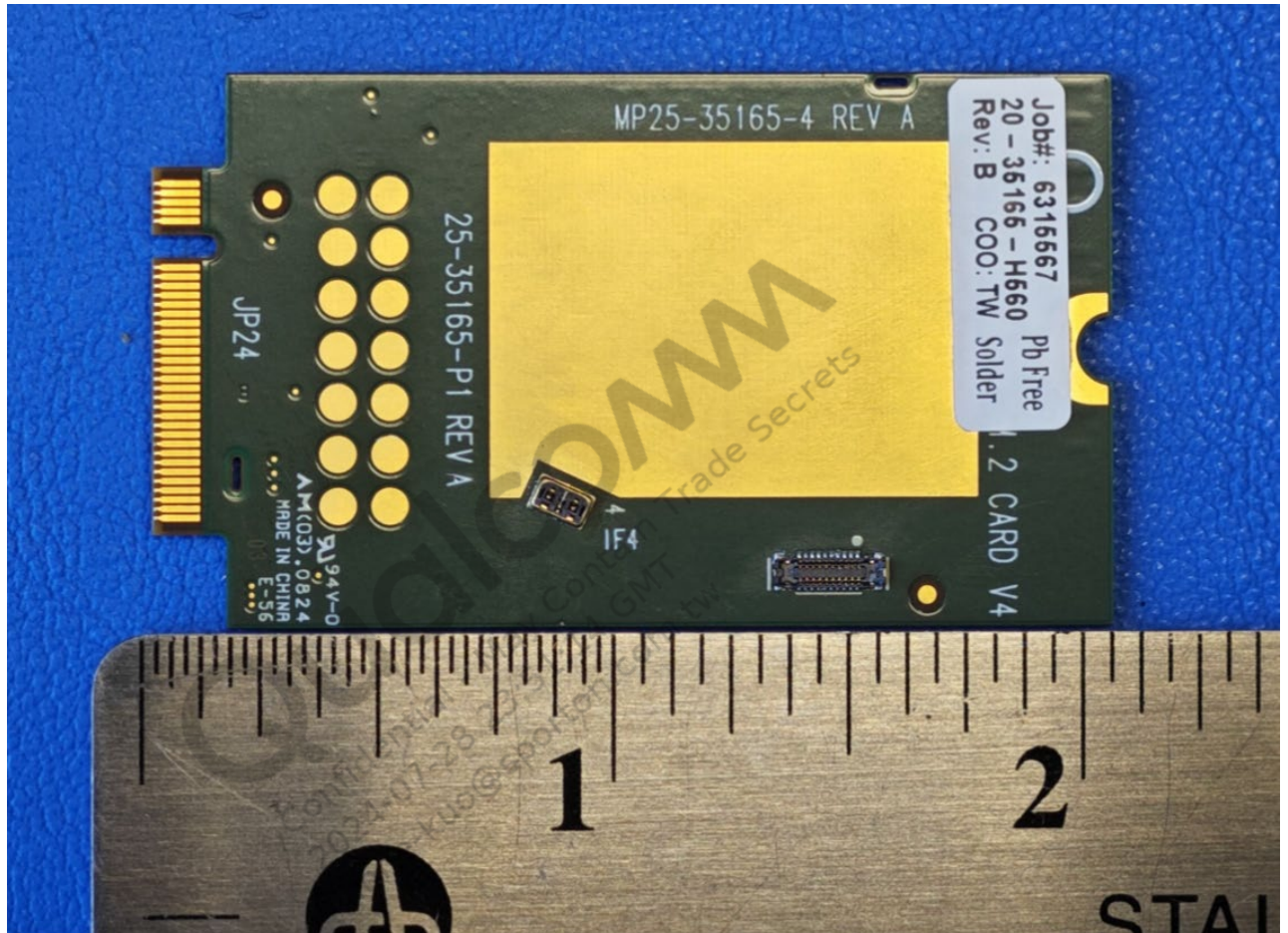
### 3 Internal Photographs

#### 3.1 Front





### 3.2 Back



### 4 Dimensions

- Length: 52mm
- Width: 30mm
- Depth: 2.3mm

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